# BCM856BS; BCM856BS/DG BCM856DS; BCM856DS/DG

**PNP/PNP** matched double transistors

Rev. 01 — 7 August 2008

**Product data sheet** 

## 1. Product profile

### 1.1 General description

PNP/PNP matched double transistors in small Surface-Mounted Device (SMD) plastic packages. The transistors are fully isolated internally.

Table 1. Product overview

Type number	Package		Package configuration
	Nexperia	JEITA	
BCM856BS	SOT363	SC-88	very small
BCM856BS/DG			
BCM856DS	SOT457	SC-74	small
BCM856DS/DG			

### 1.2 Features

- Current gain matching
- Base-emitter voltage matching
- Drop-in replacement for standard double transistors
- AEC-Q101 qualified

### 1.3 Applications

- Current mirror
- Differential amplifier

#### 1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transis	stor					
$V_{CEO}$	collector-emitter voltage	open base	-	-	-65	V
I <sub>C</sub>	collector current		-	-	-100	mA
h <sub>FE</sub>	DC current gain	$V_{CE} = -5 \text{ V};$ $I_{C} = -2 \text{ mA}$	200	290	450	



Table 2. Quick reference data ...continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per device						
h <sub>FE1</sub> /h <sub>FE2</sub>	h <sub>FE</sub> matching	$V_{CE} = -5 \text{ V};$ $I_C = -2 \text{ mA}$	[1] 0.9	1	-	
V <sub>BE1</sub> -V <sub>BE2</sub>	V <sub>BE</sub> matching	$V_{CE} = -5 \text{ V};$ $I_C = -2 \text{ mA}$	[2] _	-	2	mV

<sup>[1]</sup> The smaller of the two values is taken as the numerator.

# 2. Pinning information

Table 3. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	emitter TR1		
2	base TR1	[6] [5] [4]	6 5 4
3	collector TR2		TR2
4	emitter TR2		(TR1)
5	base TR2		
6	collector TR1	001aab555	1 2 3
			sym018

# 3. Ordering information

Table 4. Ordering information

Type number	Package					
	Name	Description	Version			
BCM856BS	SC-88	plastic surface-mounted package; 6 leads	SOT363			
BCM856BS/DG						
BCM856DS	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457			
BCM856DS/DG						

<sup>[2]</sup> The smaller of the two values is subtracted from the larger value.

## 4. Marking

Table 5. Marking codes

Type number	Marking code <sup>[1]</sup>
BCM856BS	*BS
BCM856BS/DG	PB*
BCM856DS	DS
BCM856DS/DG	R9

<sup>[1] \* = -:</sup> made in Hong Kong

# 5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per trans	istor				
$V_{CBO}$	collector-base voltage	open emitter	-	-80	V
$V_{\text{CEO}}$	collector-emitter voltage	open base	-	-65	V
$V_{\text{EBO}}$	emitter-base voltage	open collector	-	-5	V
$I_{C}$	collector current		-	-100	mA
I <sub>CM</sub>	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	-200	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$			
	BCM856BS (SOT363) BCM856BS/DG (SOT363)		<u>[1]</u> -	200	mW
	BCM856DS (SOT457) BCM856DS/DG (SOT457)		<u>[1]</u> -	250	mW
Per devic	ee				
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$			
	BCM856BS (SOT363) BCM856BS/DG (SOT363)		<u>[1]</u> -	300	mW
	BCM856DS (SOT457) BCM856DS/DG (SOT457)		<u>[1]</u> -	380	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

<sup>\* =</sup> p: made in Hong Kong

<sup>\* =</sup> t: made in Malaysia

<sup>\* =</sup> W: made in China

### 6. Thermal characteristics

Table 7 Thermal characteristics

Table 7.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	sistor					
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air				
	BCM856BS (SOT363) BCM856BS/DG (SOT363)		[1] -	-	625	K/W
	BCM856DS (SOT457) BCM856DS/DG (SOT457)		<u>[1]</u> -	-	500	K/W
Per devi	ce					
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air				
	BCM856BS (SOT363) BCM856BS/DG (SOT363)		<u>[1]</u> -	-	416	K/W
	BCM856DS (SOT457) BCM856DS/DG (SOT457)		[1] -	-	328	K/W

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

### 7. Characteristics

Table 8. Characteristics

 $T_{amb}$  = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transis	stor					
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = -30 \text{ V};$ $I_E = 0 \text{ A}$	-	-	-15	nA
		$V_{CB} = -30 \text{ V};$ $I_E = 0 \text{ A};$ $T_j = 150 ^{\circ}\text{C}$	-	-	<b>-</b> 5	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = -5 \text{ V};$ $I_{C} = 0 \text{ A}$	-	-	-100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = -5 \text{ V};$ $I_{C} = -10 \mu\text{A}$	-	250	-	
		$V_{CE} = -5 \text{ V};$ $I_C = -2 \text{ mA}$	200	290	450	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = -10 \text{ mA};$ $I_B = -0.5 \text{ mA}$	-	-50	-200	mV
		$I_C = -100 \text{ mA};$ $I_B = -5 \text{ mA}$	-	-200	-400	mV
V <sub>BEsat</sub>	base-emitter saturation voltage	$I_C = -10 \text{ mA};$ $I_B = -0.5 \text{ mA}$	<u>[1]</u> -	-760	-	mV
		$I_C = -100 \text{ mA};$ $I_B = -5 \text{ mA}$	<u>[1]</u> -	-920	-	mV

**Table 8.** Characteristics ... continued  $T_{amb} = 25 \,^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
	base-emitter voltage	$V_{CF} = -5 \text{ V};$	[2] -600	–650	-700	mV
$V_{BE}$	base-enfilter voltage	$V_{CE} = -3 \text{ V},$ $I_{C} = -2 \text{ mA}$		-030	-700	IIIV
		$V_{CE} = -5 \text{ V};$ $I_{C} = -10 \text{ mA}$	[2] _	-	-760	mV
C <sub>c</sub>	collector capacitance	$V_{CB} = -10 \text{ V};$ $I_E = i_e = 0 \text{ A};$ $f = 1 \text{ MHz}$	-	-	2.2	pF
C <sub>e</sub>	emitter capacitance	$V_{EB} = -0.5 \text{ V};$ $I_{C} = i_{c} = 0 \text{ A};$ $f = 1 \text{ MHz}$	-	10	-	pF
f <sub>T</sub>	transition frequency	$V_{CE} = -5 \text{ V};$ $I_{C} = -10 \text{ mA};$ $f = 100 \text{ MHz}$	100	175	-	MHz
NF	noise figure	$V_{CE} = -5 \text{ V};$ $I_{C} = -0.2 \text{ mA};$ $R_{S} = 2 \text{ k}\Omega;$ $f = 10 \text{ Hz to}$ $15.7 \text{ kHz}$	-	1.6	-	dB
		$V_{CE} = -5 \text{ V};$ $I_C = -0.2 \text{ mA};$ $R_S = 2 \text{ k}\Omega;$ $f = 1 \text{ kHz};$ $B = 200 \text{ Hz}$	-	3.1	-	dB
Per device						
h <sub>FE1</sub> /h <sub>FE2</sub>	h <sub>FE</sub> matching	$V_{CE} = -5 \text{ V};$ $I_C = -2 \text{ mA}$	[ <u>3</u> ] 0.9	1	-	
V <sub>BE1</sub> -V <sub>BE2</sub>	V <sub>BE</sub> matching	$V_{CE} = -5 \text{ V};$ $I_C = -2 \text{ mA}$	<u>[4]</u> -	-	2	mV

<sup>[1]</sup>  $V_{BEsat}$  decreases by about 1.7 mV/K with increasing temperature.

<sup>[2]</sup> V<sub>BE</sub> decreases by about 2 mV/K with increasing temperature.

<sup>[3]</sup> The smaller of the two values is taken as the numerator.

<sup>[4]</sup> The smaller of the two values is subtracted from the larger value.

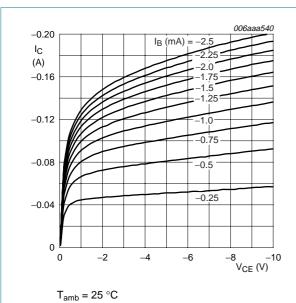
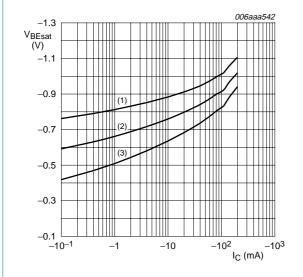


Fig 1. Collector current as a function of collector-emitter voltage; typical values



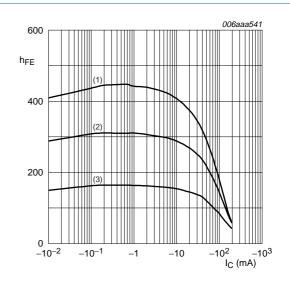
 $I_{\rm C}/I_{\rm B} = 20$ 

(1)  $T_{amb} = -55 \, ^{\circ}C$ 

(2)  $T_{amb} = 25 \,^{\circ}C$ 

(3)  $T_{amb} = 100 \, ^{\circ}C$ 

Fig 3. Base-emitter saturation voltage as a function of collector current; typical values



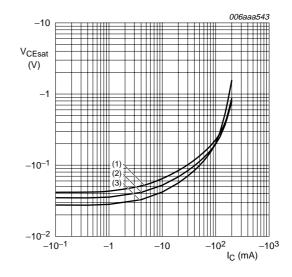
 $V_{CE} = -5 \text{ V}$ 

(1)  $T_{amb} = 100 \, ^{\circ}C$ 

(2)  $T_{amb} = 25 \, ^{\circ}C$ 

(3)  $T_{amb} = -55 \, ^{\circ}C$ 

Fig 2. DC current gain as a function of collector current; typical values



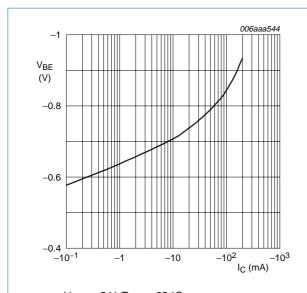
 $I_{\rm C}/I_{\rm B} = 20$ 

(1)  $T_{amb} = 100 \, ^{\circ}C$ 

(2)  $T_{amb} = 25 \,^{\circ}C$ 

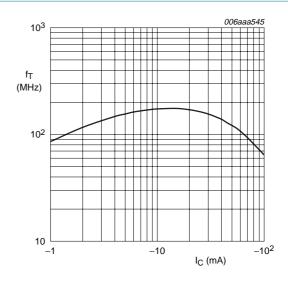
(3)  $T_{amb} = -55 \, ^{\circ}C$ 

Fig 4. Collector-emitter saturation voltage as a function of collector current; typical values



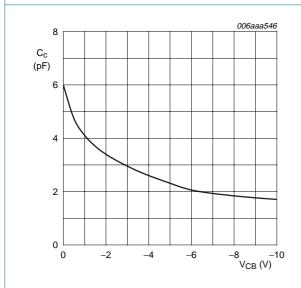
 $V_{CE} = -5 \text{ V}; T_{amb} = 25 \text{ }^{\circ}\text{C}$ 

Fig 5. Base-emitter voltage as a function of collector current; typical values



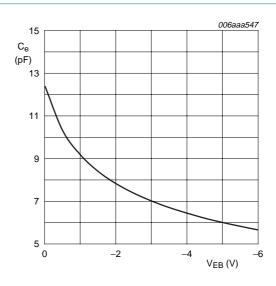
 $V_{CE} = -5 \text{ V}; T_{amb} = 25 ^{\circ}\text{C}$ 

Fig 6. Transition frequency as a function of collector current; typical values



collector-base voltage; typical values

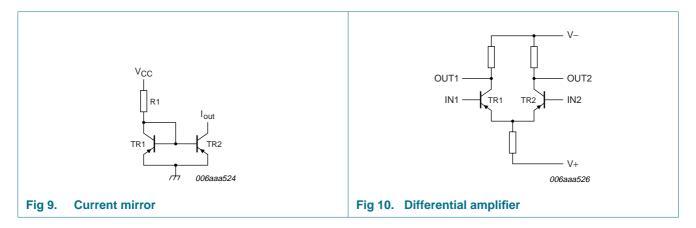
 $f = 1 \text{ MHz}; T_{amb} = 25 \text{ °C}$  Fig 7. Collector capacitance as a function of



 $f = 1 \text{ MHz}; T_{amb} = 25 \,^{\circ}\text{C}$ 

Fig 8. Emitter capacitance as a function of emitter-base voltage; typical values

# 8. Application information

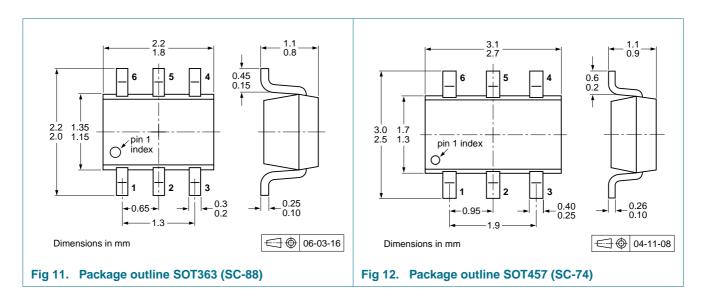


### 9. Test information

### 9.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

## 10. Package outline



# 11. Packing information

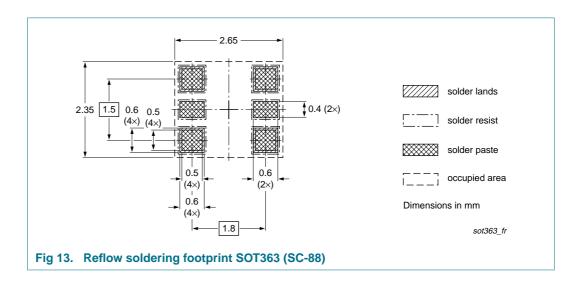
Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package Description		Packing quantity		
				3000	10000
BCM856BS	SOT363	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-135
		4 mm pitch, 8 mm tape and reel; T2	[3]	-125	-165
BCM856BS/DG	S/DG SOT363	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-135
		4 mm pitch, 8 mm tape and reel; T2	[3]	-125	-165
BCM856DS	SOT457	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-135
		4 mm pitch, 8 mm tape and reel; T2	[3]	-125	-165
BCM856DS/DG SOT457	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-135	
		4 mm pitch, 8 mm tape and reel; T2	[3]	-125	-165

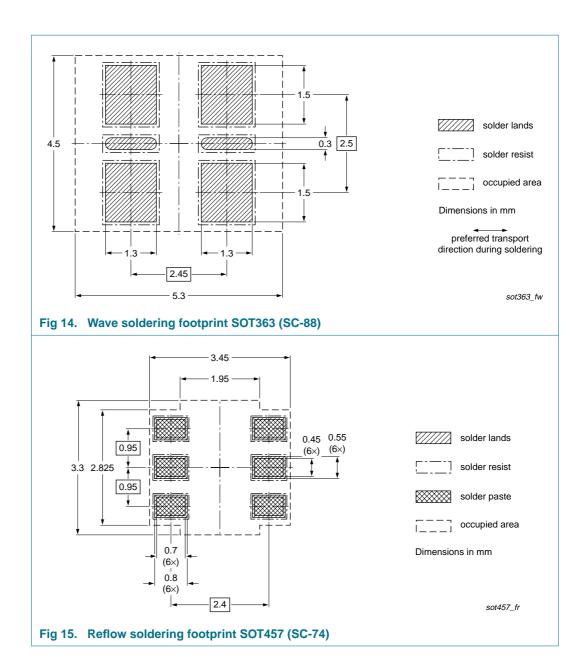
<sup>[1]</sup> For further information and the availability of packing methods, see Section 15.

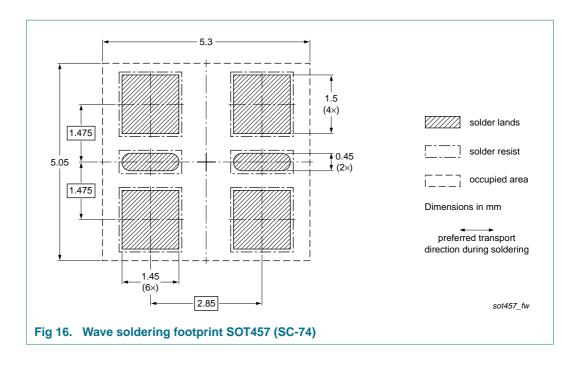
## 12. Soldering



<sup>[2]</sup> T1: normal taping

<sup>[3]</sup> T2: reverse taping





# 13. Revision history

### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BCM856BS_BCM856DS_1	20080807	Product data sheet	-	-

# BCM856BS; BCM856DS

PNP/PNP matched double transistors

### 14. Legal information

#### 14.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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# BCM856BS; BCM856DS

### **Nexperia**

**PNP/PNP** matched double transistors

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